







TL103W, TL103WA, TL103WB APRIL 2004 - REVISED OCTOBER 2023

TL103Wx Dual Operational Amplifiers With Internal Reference

1 Features

- New TL103WB, a pin-compatible upgrade to the TL103W and TL103WA
- Improved specifications of B version amplifiers:
 - Supply range: 3 V to 36 V
 - Low maximum input offset voltage: ±2 mV (25°C) and ±2.5 mV (full temperature)
 - Gain bandwidth: 1.2 MHz
 - Total supply current: 550 μA
 - EMI rejection: integrated RF and EMI filter
 - Temperature range: -40°C to 125°C
- Improved specifications of B version reference:
 - Fixed 2.5-V reference
 - Tight tolerance maximum of 0.44% (25°C) and 1.04% (full temperature)
 - Wide sink-current range: 0.2 mA (typical) to 100 mA

2 Applications

- **Battery chargers**
- Switch-mode power supplies
- Linear voltage regulation
- **Data-acquisition systems**
- Precision constant current sink

3 Description

The TL103Wx devices combine the building blocks of a dual operational amplifier and a fixed voltage reference - both of which are often used in the control circuitry of switch-mode and linear power supplies. OP AMP1 has the non-inverting input internally tied to a fixed 2.5-V reference, while OP AMP2 is independent, with both inputs uncommitted.

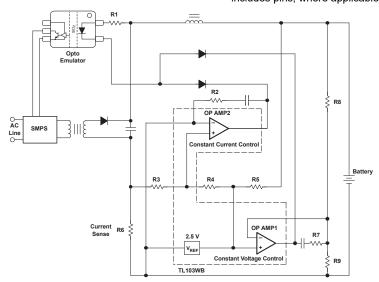
The upgraded TL103WB features improvements such as a wider supply range (up to 36 V), lower supply current (275 µA/amp) and tighter voltage regulation. This regulation can be achieved through low offset voltages for both operational amplifiers (0.3 mV typical) and tight tolerances for the voltage reference (0.44% at 25°C and 1.04% over operating temperature range).

The TL103WB has a widened temperature range of -40°C to 125°C.

Device Information

PART NUMBER	CHANNEL COUNT	PACKAGE ⁽¹⁾	PACKAGE SIZE(3)
TL103W TL103WA		D (SOIC, 8)	4.9 mm × 6 mm
TL103WB	Dual + Reference	D (SOIC, 8)	4.9 mm × 6 mm
ILIOSVID		DDF (SOT-23, 8) (2)	2.9 mm × 2.8 mm

- (1) For all available packages, see the orderable addendum at the end of the data sheet.
- This package is preview only.
- The package size (length × width) is a nominal value and includes pins, where applicable.



Typical Application Circuit



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4 Revision History

NOTE: Page numbers for previous revisions may differ from page numbers in the current version.

Changes from Revision N (August 2023) to Revision O (O	ctober 2023) Pag
Changed maximum input offset voltage, reference tolerand the Features section	
Changed Typical Application Circuit figure to include TL103	
 Changed TL103WB D (SOIC, 8) status from advanced info 	
Changed <i>Thermal Information</i> table to include latest therm	
Added DDF information to <i>Thermal Information</i> table	
Updated k _{SVR} term to PSRR	
 Changed maximum short circuit current from ±60 mA to ±6 	8 mA
Maximum reference input voltage deviation over temperatus 35 mV	re range for TL103W was changed from 30 mV to
Maximum reference input voltage deviation over temperatute to 26 mV	re range for TL103WA was changed from 30 mV
· Added figures to the Typical Characteristics section to high	
Added the Detailed Description and Application and Imple	
Added the Application and Implementation sections	
Changes from Revision M (October 2016) to Revision N (A	August 2023) Pag
Updated Features section to highlight TL103WB	
· Updated the numbering format for tables, figures, and cros	
 Added the TL103WB device information throughout the do 	
Updated Description section	
• Updated Device Information table to include channel count	I
 Removed DRJ package details and added DDF package for 	
Updated formatting for <i>Electrical Characteristics</i> tables	
• Updated typical dynamic impedance from 0.2 Ω to 0.45 Ω	n Electrical Characteristics tables
Changes from Revision L (February 2016) to Revision M (October 2016) Pag
Changed positive and negative terminals OP AMP 2 in the	D Package image of <i>Pin Configuration and</i>
Functions	



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C	hanges from Revision K (October 2010) to Revision L (February 2016)	Page
•	Added the Device Information table, Pin Configuration and Functions, ESD Ratings, Thermal Information	on,
	Device and Documentation Support, and Mechanical, Packaging, and Orderable Information sections	1
•	Changed Features from: 2 kV ESD Protection (HBM) to: 2.5-kV ESD Protection (HBM)	1
•	Changed the Zener diode component to V _{REF} in the <i>Typical Application Circuit</i>	1
	Changed the Zener diode component to V _{REF} in the D Package of <i>Pin Configuration and Functions</i>	

5 Pin Configuration and Functions

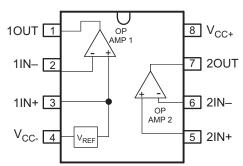


Figure 5-1. D and DDF Packages, 8-Pin SOIC and SOT-23-THN (Top View)

Table 5-1. Pin Functions

PIN		TYPE(1)	DESCRIPTION	
NAME	NO.	ITPE\''	DESCRIPTION	
10UT	1	0	Opamp 1 output	
1IN-	2	I	Opamp 1 inverting input	
1IN+	3	I	amp 1 non-inverting input and Shunt reference cathode terminal	
V _{CC} -	4	I	gative Supply Voltage	
2IN+	5	I	Opamp 2 non-inverting input	
2IN-	6	I	Opamp 2 inverting input	
2OUT	7	0	amp 2 output	
V _{CC+}	8	I	Positive Supply Voltage	

(1) I = input, O = output

6 Specifications

6.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted)(1)

			MIN	MAX	UNIT
V	Cumply valtage	TL103W/TL103WA	0	36	V
V _{CC±}	Supply voltage	TL103WB	0	40	V
V _{ID}	Operational amplifier input differential voltage			36	V
VI	Operational amplifier input voltage range ⁽²⁾		(V _{CC-}) - 0.3	V _{CC+}	V
I _{KA}	Voltage reference cathode current			100	mA
TJ	Maximum junction temperature			150	°C
T _{stg}	Storage temperature range		-65	150	°C

Stresses beyond those listed under Absolute Maximum Rating may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Condition. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(2) Not applicable to pin 4 (1IN+)

6.2 ESD Ratings

			VALUE	UNIT
V		Human body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾	±2500	V
V _(ESD) Electrostatic discharge	Charged device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾	±1000	v	

⁽¹⁾ JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

6.3 Recommended Operating Conditions

over operating free-air temperature range (unless otherwise noted)

			MIN	MAX	UNIT
V	Supply voltage	TL103W/TL103WA	3	32	V
V _{CC±}	Supply voltage	TL103WB	3	36	v
V _{ICR}	Input common-mode voltage range		V _{CC-}	(V _{CC+}) - 2	V
	Cathode current	TL103W/TL103WA	0.5	100	mA
IK	Cathode current	TL103WB	0.2	100	IIIA
_	Operating free air temperature	TL103W/TL103WA	-40	105	°C
T _A	Operating free-air temperature	TL103WB	-40	125	C

6.4 Thermal Information

		TL		
	THERMAL METRIC ⁽¹⁾	SOIC (D)	SOT-23 (DDF)	UNIT
		8 PINS	8 PINS	
R _{θJA}	Junction-to-ambient thermal resistance	135.4	170.1	°C/W
R _{θJC(top)}	Junction-to-case (top) thermal resistance	77.3	89.7	°C/W
$R_{\theta JB}$	Junction-to-board thermal resistance	78.9	87.5	°C/W
Ψ_{JT}	Junction-to-top characterization parameter	27.4	7.5	°C/W
Ψ_{JB}	Junction-to-board characterization parameter	78.1	87.3	°C/W

⁽²⁾ JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.



6.4 Thermal Information (continued)

		TL10		
	THERMAL METRIC ⁽¹⁾			UNIT
		8 PINS	8 PINS	
R _{0JC(bot)}	Junction-to-case (bottom) thermal resistance	_	-	°C/W

⁽¹⁾ For more information about traditional and new thermal metrics, see the Semiconductor and IC Package Thermal Metrics application report.

6.5 Electrical Characteristics: OP AMP1 (V_{REF} at Noninverting input)

 $V_{CC+} = 5 \text{ V}, V_{CC-} = \text{GND}, T_{\Delta} = 25^{\circ}\text{C}$ (unless otherwise noted)

	PARAMETER	TEST	CONDITIONS		T _A	MIN	TYP	MAX	UNIT	
AMPLIFI	ER									
							±1	±4		
				TL103W	Full range			±5		
							±0.5	±3.0		
V _{IO}	Input offset voltage	V _{ICM} = 0 V		TL103WA	Full range			±5	mV	
				TI 40014/D			±0.3	±2		
				TL103WB	Full range			±2.5		
~\\ /	lanut offect veltage drift			TL103W/TL103WA	Full range		±7		μV/°C	
αV _{IO}	Input offset-voltage drift			TL103WB	Full range		±2		μν/ C	
1	Input bias current (negative input)			TL103W/TL103WA			-20		nA	
IB	input bias current (negative input)			TL103WB			-15		IIA	
A _{VD}	Large-signal voltage gain	$V_{CC+} = 15 \text{ V}, R_1 = 2k\Omega, V_{ICM} = 0 \text{ V}$		TL103W/TL103WA			100		V/mV	
טעיר	Large-signal voltage gain	VCC+ - 13 V, INL - 2K12, VICM - U V		TL103WB			140		V/111V	
PSRR	Supply-voltage rejection ratio	V _{CC+} = 5 V to 30 V, V _{ICM} = 0 V		TL103W/TL103WA		65	100		dB	
Orac	Ouppry-voitage rejection ratio	VCC+ - 5 V to 50 V, VICM - 0 V		TL103WB		80	114			
			Source			20	40		mA	
		V _{CC+} = 15 V, V _O = 2 V, V _{ID} = 1 V	Sink	TL103W/TL103WA		10	12			
lo	Output current			TL103WB		10	24			
		V _{CC+} = 15 V, V _O = 0.2 V, V _{ID} = -1 V	Sink	TL103W/TL103WA		12	50		μA	
		1007 10 1, 10 11 1, 110 1		TL103WB		60	100			
I _{sc}	Short-circuit to GND	V _{CC+} = 15 V					±40	±68	mA	
		$V_{CC+} = 30 \text{ V}, R_L = 2 \text{ k}\Omega$		TL103W/TL103WA		26	27			
			Positive Rail (V _{CC+})		Full range	26			- V	
				TL103WB		27.4	28.3			
					Full range	27.4				
V _o	Voltage output swing from rail	V_{CC+} = 30 V, R_L = 10 k Ω	Positive Rail (V _{CC+})	TL103W/TL103WA		27	28			
					Full range	27				
				TL103WB	F	27.6	28.6			
					Full range	27.6				
		$R_L = 10 \text{ k}\Omega$	Negative Rail (V _{CC-})		Full renge		5	20	mV	
				TI 402\M/TI 402\M/A	Full range	0.2	0.4			
SR	Slew rate at unity gain	$V_{CC+} = 15 \text{ V}, C_L = 100 \text{ pF}, R_L = 2 \text{ k}\Omega, V_{CC+}$	$V_{\rm I}$ = 0.5 V to 2V, unity gain	TL103W/TL103WA TL103WB		0.2			V/µs	
		V _{CC+} = 30 V, V _I = 10 mV, C _I = 100 pF,	P = 2 kO f = 100 kHz	TL103WB		0.2	0.5			
GBW	Gain bandwidth product	$V_{CC+} = 36 \text{ V}, V_I = 10 \text{ mV}, C_L = 100 \text{ pF},$		TL103W/TL103WA		0.5	1.2		MHz	
		$V_{CC+} = 30 \text{ V}, V_{O} = 2 \text{ V}_{PP}, C_{L} = 100 \text{ pF},$				0.5				
TUD	Takal bassas asia diakandian	= 20 dB	11 - 2 K12, 1 - 1 K112, My	TL103W/TL103WA			0.02		%	
THD Total harmonic distortion		V_{CC+} = 36 V, V_{O} = 2 V_{PP} , C_{L} = 100 pF, R_{L} = 2 k Ω , f = 1 kHz, A_{V} = 20 dB		TL103WB			0.005		70 I	
		V _{CC+} = 5 V, no load		TL103W/TL103WA			0.7	1.2		
1	Total supply current, excluding cathode-current reference (both	V _{CC+} = 30 V, no load		TETUSW/TETUSWA	Full range			2		
cc	amplifiers)	V _{CC+} = 5 V, no load		TL103WB			0.55	0.92	mA	
		V _{CC+} = 36 V, no load		15103440	Full range			1.6		



6.5 Electrical Characteristics: OP AMP1 (V_{REF} at Noninverting input) (continued)

 $V_{CC+} = 5 \text{ V}, V_{CC-} = \text{GND}, T_A = 25^{\circ}\text{C} \text{ (unless otherwise noted)}$

	PARAMETER	TEST CONDITIONS		TA	MIN	TYP	MAX	UNIT
			TL103W		2.482	2.5	2.518	V
ΔV _{ref} R o	Reference Voltage	 _K = 10 mA	TL 103VV	Full Range	2.465		2.535	V
	Reference voltage	I _K = 10 mA	TL103WA/TL103WB		2.489	2.5	2.511	٧
			TE 103WA/TE 103WB	Full Range	2.474		2.526	V
۸۱/	Reference input voltage deviation	I _K = 10 mA	TL103W	Full Range		7 35	mV	
Δv _{ref}	over temperature range	IK - 10 IIIA	TL103WA/TL103WB	Full Range		7	26	mV
	Minimum cathode current for	or TL	TL103W/TL103Wx			0.5	1	mA
¹min	regulation		TL103WB			0.2	1	IIIA
Z _{KA}	Dynamic impedance	I _{KA} = 1 mA to 100 mA, f < 1 kHz				0.45	0.5	Ω

6.6 Electrical Characteristics: OP AMP2 (Independent Amplifier)

	PARAMETER		TA	MIN	TYP	MAX	UNIT			
				TI 100111			±1	±4		
				TL103W	Full range			±5		
							±0.5	±3.0		
V _{IO}	Input offset voltage	V _{ICM} = 0 V		TL103WA	Full range			±5	mV	
				TI 400\A/D			±0.3	±2		
				TL103WB	Full range			±2.5		
-3.7	land for the land			TL103W/TL103WA	Full range		±7			
αV _{IO}	Input offset-voltage drift			TL103WB	Full range		±2		μV/°C	
				TI 400\A/TI 400\A/A			±2	±75		
	Innut effect coment			TL103W/TL103WA	Full range			±150	^	
I _{IO}	Input offset current				±0.5	±4	nA			
				TL103WB	Full range			±5		
				TL103W/TL103WA			-20	-150		
I _{IB} Input bias cu			Full range			-200				
	Input bias current						-15	-35	nA	
			TL103WB					-		
					Full range		400	-50		
			TL103W/TL103WA	F. II	50	100				
A_{VD}	Large-signal voltage gain	$V_{CC+} = 15 \text{ V}, R_L = 2k\Omega, VO = 1.4 \text{ V to 1}$		Full range	25 70	100		V/mV		
			TL103WB	Full reners	35	140				
				TL103W/TL103WA	Full range	65	100			
PSRR	Supply-voltage rejection ratio	V _{CC+} = 5 V to 30 V		TL103W/TL103WA		80	114		dB	
				TE 103WB			114	()/)		
.,	land a second second	N 00 V				V_{CC}		(V _{CC+}) - 1.5		
V _{ICR}	Input common-mode voltage range	V _{CC+} = 30 V		Full range	V _{CC} -		(V _{CC+}) - 2	V		
OMDD	0	v 20.V				70	95		dB	
CMRR	Common-mode rejection ratio	V _{CC+} = 30 V			Full range	60				
			Source			20	40			
		V _{CC+} = 15 V, V _O = 2 V, V _{ID} = 1 V	Sink	TL103W/TL103WA		10	12		mA	
Io	Output current		SITIK	TL103WB		10	24			
		V _{CC+} = 15 V, V _O = 0.2 V, V _{ID} = -1 V	Sink	TL103W/TL103WA		12	50			
		VCC+ - 13 V, VO = U.Z V, VID = -1 V	TL103WB		60	100		μA		
I _{SC}	Short-circuit to GND	V _{CC+} = 15 V	· ·				±40	±68	mA	



6.6 Electrical Characteristics: OP AMP2 (Independent Amplifier) (continued)

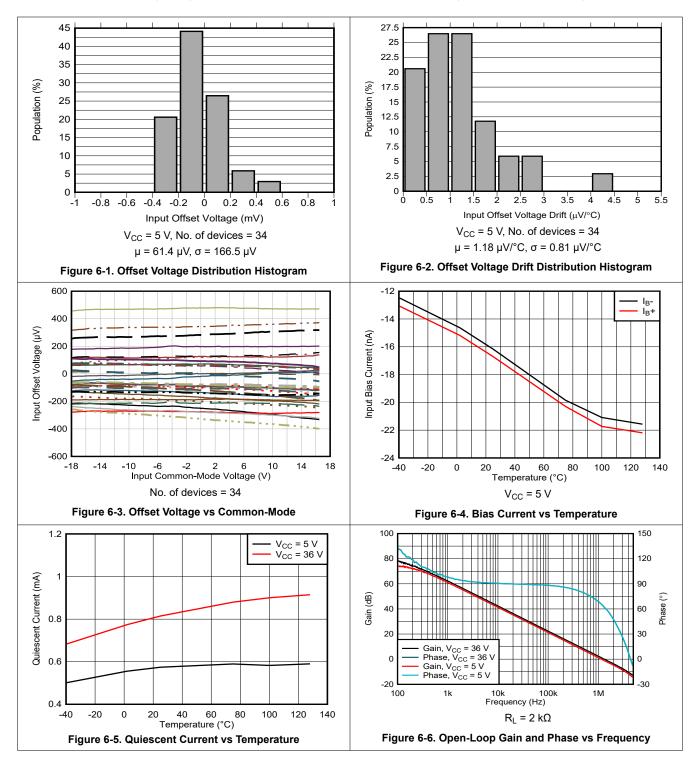
 $V_{CC+} = 5 \text{ V}, V_{CC-} = \text{GND}, T_A = 25^{\circ}\text{C} \text{ (unless otherwise noted)}$

	PARAMETER	TEST	T _A	MIN	TYP	MAX	UNIT		
				TL103W/TL103WA		26	27		
		V _{CC+} = 30 V. R _I = 2 kΩ	Positive Rail (V _{CC+})	TE103VV/TE103VVA	Full range	26			
		V _{CC+} = 30 V, R _L = 2 KΩ	Positive Raii (V _{CC+})	TL103WB		27.4	28.3		
				ILIUSWB	Full range	27.4			v
Vo	Voltage output swing from rail			TL103W/TL103WA		27	28		
v _O	voitage output swing from rail	$V_{CC+} = 30 \text{ V, R}_1 = 10 \text{ k}\Omega$	Positive Rail (V _{CC+})	TE103VV/TE103VVA	Full range	27			
		V _{CC+} = 30 V, IV _L = 10 K22	Fositive Itali (V _{CC+})	TL103WB		27.6	28.6		
				TETOSVIB	Full range	27.6			
		R _L = 10 kΩ	Negative Rail (V _{CC})				5	20	mV
			Negative Rail (V _{CC-})		Full range			20	
SR	R Slew rate at unity gain	$V_{CC+} = 15 \text{ V}, C_1 = 100 \text{ pF}, R_1 = 2 \text{ k}\Omega, $	TL103W/TL103WA		0.2	0.4		V/µs	
SIX	Siew rate at unity gain	V _{CC+} = 13 V, C _L = 100 β1, 1\(\frac{1}{2}\) = 2 K22, \(\frac{1}{2}\)	TL103WB		0.2	0.5		ν/μ5	
GBW	Gain bandwidth product	$V_{CC+} = 30 \text{ V}, V_I = 10 \text{ mV}, C_L = 100 \text{ pF},$	TL103W/TL103WA		0.5	0.9		MHz	
GDW	Gaiir bandwidiir product	$V_{CC+} = 36 \text{ V}, V_I = 10 \text{ mV}, C_L = 100 \text{ pF},$	TL103WB		0.5	1.2		IVII IZ	
THD	Total harmonic distortion	$V_{CC+} = 30 \text{ V}, V_O = 2 \text{ V}_{PP}, C_L = 100 \text{ pF},$ = 20 dB	TL103W/TL103WA			0.02		%	
טחו	Total Harmonic distortion	$V_{CC+} = 36 \text{ V}, V_O = 2 \text{ V}_{PP}, C_L = 100 \text{ pF},$ = 20 dB	TL103WB			0.005		1 70	
Vn	Equivalent input noise voltage	V _{CC+} = 30 V, R _S = 100 Ω, f = 1 kHz		TL103W/TL103WA			50		nV/√Hz
v _n	Equivalent input noise voltage	$V_{CC+} = 36 \text{ V}, R_S = 100 \Omega, f = 1 \text{ kHz}$	V _{CC+} = 36 V, R _S = 100 Ω, f = 1 kHz				38		IIV/VIIZ
		V _{CC+} = 5 V, no load	TL103W/TL103WA			0.7	1.2	mA	
1	Total supply current, excluding cathode-current reference (both	V _{CC+} = 30 V, no load	ILIUSW/ILIUSWA	Full range			2		
I _{CC}	amplifiers)	V _{CC+} = 5 V, no load		TL103WB			0.55	0.92	1 mA
		V _{CC+} = 36 V, no load	ILIUSWD	Full range			1.6		



6.7 Typical Characteristics: TL103WB

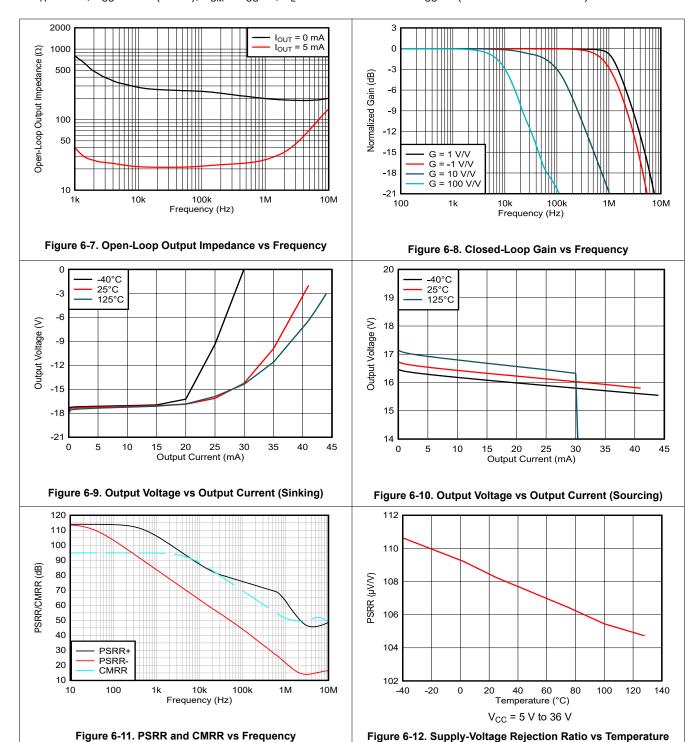
at $T_A \cong 25^{\circ}\text{C}$, $V_{CC} = 36 \text{ V (\pm 18 V)}$, $V_{CM} = V_{CC} / 2$, $R_L = 10 \text{ k}\Omega$ connected to $V_{CC} / 2$ (unless otherwise noted)





6.7 Typical Characteristics: TL103WB (continued)

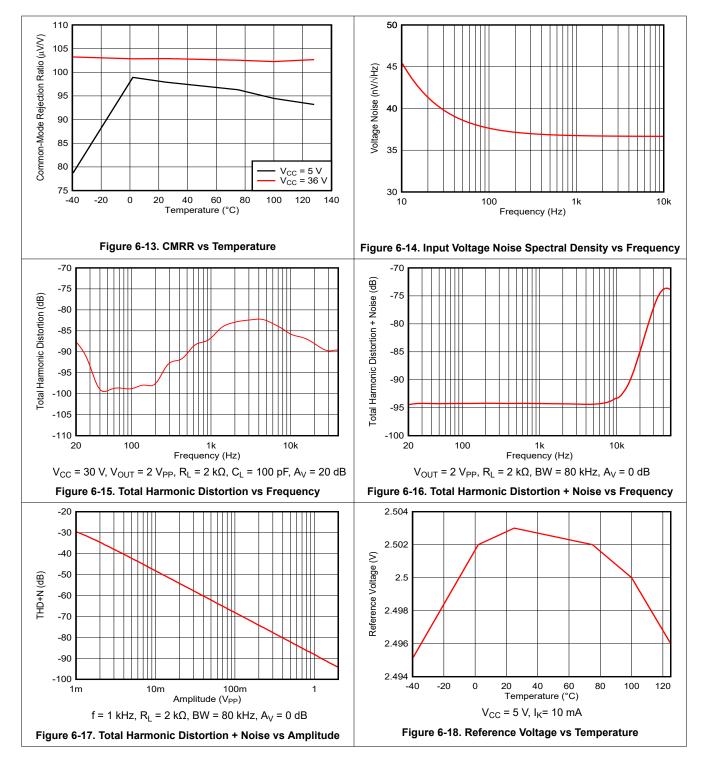
at $T_A \cong 25^{\circ}\text{C}$, V_{CC} = 36 V (±18 V), V_{CM} = V_{CC} / 2, R_L = 10 k Ω connected to V_{CC} / 2 (unless otherwise noted)





6.7 Typical Characteristics: TL103WB (continued)

at $T_A \cong 25^{\circ}\text{C}$, $V_{CC} = 36 \text{ V (\pm 18 V)}$, $V_{CM} = V_{CC} / 2$, $R_L = 10 \text{ k}\Omega$ connected to $V_{CC} / 2$ (unless otherwise noted)





6.7 Typical Characteristics: TL103WB (continued)

at $T_A \cong 25^{\circ}\text{C}$, $V_{CC} = 36 \text{ V (\pm 18 V)}$, $V_{CM} = V_{CC} / 2$, $R_L = 10 \text{ k}\Omega$ connected to $V_{CC} / 2$ (unless otherwise noted)

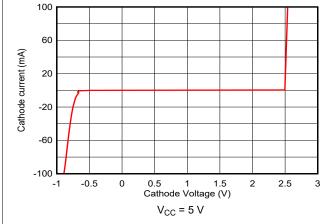


Figure 6-19. Cathode Current vs Cathode Voltage

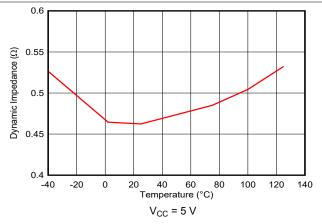


Figure 6-20. Reference Dynamic Impedance vs Temperature

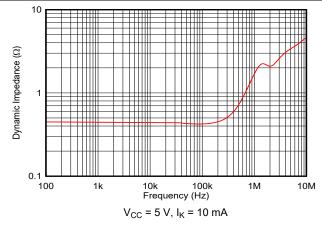
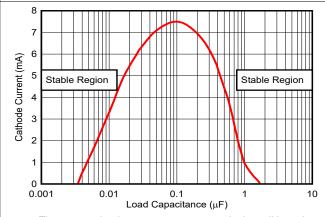


Figure 6-21. Reference Dynamic Impedance vs Frequency



The area under the curve represents typical conditions that can cause the device to oscillate

Figure 6-22. Reference Stability vs Capacitive Load

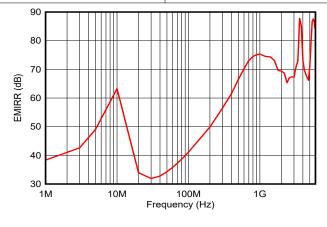


Figure 6-23. EMIRR (Electromagnetic Interference Rejection Ratio) vs Frequency

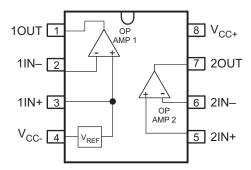
7 Detailed Description

7.1 Overview

The TL103Wx features two high-voltage amplifiers and a shunt voltage reference to allow for cost-sensitive and compact battery charger CC/CV feedback circuits. The upgraded TL103WB features is designed to provide a wide supply range (up to 36V), low offset voltage (±0.3 mV typical) and a 1.2 MHz bandwidth. The integrated voltage reference is tied to the non-inverting pin of one of OP AMP 1 and provides a fixed 2.5 V referenced to the negative supply of the device. The shunt reference of the TL103WA/TL103WB features a tight tolerance of 0.44% at 25°C.

When a single supply voltage of 5 V is used (or ±2.5 V split supply), the TL103Wx internal reference allows for a more accurate and power-efficient mid-supply signal to be used throughout your circuit. The TL103W/ TL103WA devices are characterized for operation from -40°C to 85°C, the TL103WB devices are characterized for operation from -40°C to 125°C.

7.2 Functional Block Diagram



7.3 Feature Description

7.3.1 Internal Reference

The TL103Wx family features an internal shunt reference, tied to the non-inverting pin of one of the devices amplifiers. When supplied with enough voltage headroom (≥ 2.5 V) and cathode current (0.5 mA typical), the reference of the TL103Wx is forced to a fixed 2.5 V. To not exceed the maximum cathode current, be sure that the reference input is current limited. Unlike many linear regulators, the reference of the TL103W is internally compensated to be stable without an output capacitor between the cathode and anode. If the reference is used to supply a load, stability criteria shown in Figure 6-22 needs to be met.

Reference voltage tolerance varies based off the device grade chosen. At 25°C the TL103W features a reference tolerance of 0.72%, while the TL103WA/TL103WB both feature reference tolerances of 0.44%.

7.3.2 Input Common Mode Range

The valid common mode range is from device ground to $V_{CC+} - 1.5 \text{ V}$ ($V_{CC+} - 2 \text{ V}$ across temperature). Inputs may exceed V_{CC+} up to the absolute maximum voltage without device damage. At least one input must be in the valid input common-mode range for the output to be the correct phase. If both inputs exceed the valid range, then the output phase is undefined. If either input is more than 0.3 V below V_{CC-} then input current should be limited to 1 mA and the output phase is undefined.

7.3.3 EMI Rejection

The TL103WB uses integrated electromagnetic interference (EMI) filtering to reduce the effects of EMI from sources such as wireless communications (radio frequency interference - RFI) and densely-populated boards with a mix of analog signal chain and digital components. EMI immunity can be improved with circuit design techniques; the TL103WB benefits from these design improvements. Texas Instruments has developed the ability to accurately measure and quantify the immunity of an operational amplifier over a broad frequency spectrum extending from 10 MHz to 6 GHz. Figure 7-1 shows the results of this testing on the TL103WB. Table 7-1 shows the EMIRR IN+ values for the TL103WB at particular frequencies commonly encountered in real-world applications. The *EMI Rejection Ratio of Operational Amplifiers* application report contains detailed information on the topic of EMIRR performance relating to op amps and is available for download from www.ti.com.

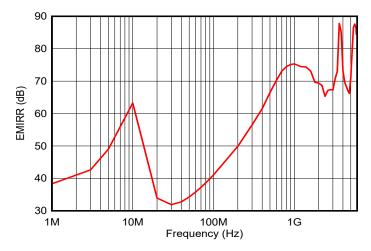


Figure 7-1. EMIRR Testing

Table 7-1. TL103WB EMIRR IN+ for Frequencies of Interest

FREQUENCY	APPLICATION OR ALLOCATION	EMIRR IN+
400 MHz	Mobile radio, mobile satellite, space operation, weather, radar, ultra-high frequency (UHF) applications	48 dB
900 MHz	Global system for mobile communications (GSM) applications, radio communication, navigation, GPS (to 1.6 GHz), GSM, aeronautical mobile, UHF applications	58 dB
1.8 GHz	GSM applications, mobile personal communications, broadband, satellite, L-band (1 GHz to 2 GHz)	75 dB
2.4 GHz	802.11b, 802.11g, 802.11n, Bluetooth®, mobile personal communications, industrial, scientific and medical (ISM) radio band, amateur radio and satellite, S-band (2 GHz to 4 GHz)	90 dB
3.6 GHz	Radiolocation, aero communication and navigation, satellite, mobile, S-band	95 dB
5 GHz	802.11a, 802.11n, aero communication and navigation, mobile communication, space and satellite operation, C-band (4 GHz to 8 GHz)	102 dB

7.4 Device Functional Modes

This device has one mode of operation that applies when operated within the recommended operating conditions.



8 Application and Implementation

Note

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes, as well as validating and testing their design implementation to confirm system functionality.

8.1 Application Information

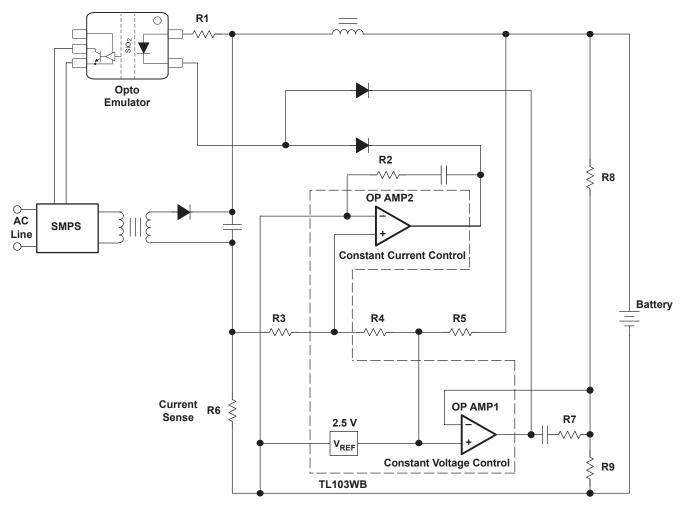
The TL103Wx family offers a cost-effective and compact device for applications requiring both an accurate DC signal and signal conditioning. These devices offer a fixed 2.5 V reference, wide bandwidth (1 to 1.2 MHz) and a low total supply current (0.55 to 0.7 mA).

8.2 Typical Applications

8.2.1 Isolated Flyback CC/CV Feedback

As shown in Figure 8-1, the TL103Wx is often used alongside an opto-coupler/opto-emulator to provide feedback to an isolated flyback. Utilizing the TL103Wx in this way allows for both an accurate and cost-optimized battery charger design that can achieve a stable CC/CV (Constant Current/Constant Voltage) charging profile. In this example, a simplified design procedure will be discussed. Additional details can be found in *Designing CC-CV Feedback Circuits With the TL103WB*.





Typical Application Circuit

8.2.1.1 Design Requirements

The objective is to design an accurate CC-CV feedback circuit with the requirements specified in Table 8-1.

Table 8-1. Design Parameters

PARAMETER	VALUE				
Maximum Charge Current	6 A				
Battery Voltage Range	6V to 20 V				

8.2.1.2 Detailed Design Procedure

To switch between CV control and CC control, diodes are utilized to achieve an OR logic function as shown in Figure 8-1. Designing the circuit in this way allows one of the amplifiers (configured in either CC or CV mode) to dominate the feedback in the design. In this design, "GND" refers to the negative node at the secondary side of the switch-mode power supply.

The fixed 2.5 V of the TL103Wx reference provides a stable DC voltage that is used to specify the CC current and CV voltage. One of the requirements of achieving this fixed value, however, is that the cathode of the reference must be supplied with a voltage of 2.5 V or above.

8.2.1.2.1 Constant Current Circuit

For the constant current feedback circuit, the amplifier is configured in a low-side current sense configuration. Resistor R6 is used as the current sensing resistor to sense the current flowing between the battery and flyback converter. This is shown in Equation 1, where I_{BAT} is the output current delivered to the battery. The voltage at the non-inverting input of the amplifier specifies the maximum current (or constant current) that is delivered to the battery.

$$V_{BAT} = I_{BAT} \times R6 \tag{1}$$

The reference of the TL103Wx is powered by the battery voltage. To be able to achieve a constant current, this reference needs to be provided with 2.5 V or greater to provide a fixed 2.5 V. The first step in designing a constant current circuit is to specify that 2.5 V can be achieved at the battery's minimum voltage. The value of R5 must also be designed so that a sink-current between 0.5 mA to 100 mA (for TL103WA) is achieved across the specified range of the battery voltage. These two steps are shown below.

$$V_{BAT}(min) \times \frac{R4 + R3}{R4 + R3 + R5 + R6} \ge 2.5 \text{ V}$$
 (2)

$$0.5 \text{ mA} \le \frac{V_{BAT} - V_{REF}}{R5} \le 100 \text{ mA}$$
 (3)

For this design R5 is chosen to be 2 k Ω . Knowing this and the specified battery range of 6 V to 20 V, we can calculate that the reference sinks anywhere from 1.75 mA to 10 mA using Equation 2.

Once a fixed 2.5 V reference is achieved, we can use this accurate DC voltage to specify a constant current target on the non-inverting input of the amplifier. This can be done by calculating the voltage at the amplifier's inverting input when a constant current target is achieved. Specifying R6 to be 10 m Ω along with a constant current design target of 6 A, we find that this voltage to be 60 mV using Equation 1. The voltage at the non-inverting pin of the amplifier is specified by Equation 4.

$$V_{IN+} = 2.5 \, V \times \frac{R3}{R4 + R3} \tag{4}$$

Using the component values and design targets calculated so far, Equation 2 and Equation 4 can be updated to:

$$6 V \times \frac{R4 + R3}{R4 + R3 + 2 k\Omega + 10 m\Omega} \ge 2.5 V \tag{5}$$

$$60 \ mV = 2.5 \ V \times \frac{R3}{R4 + R3} \tag{6}$$

Using both Equation 5 and Equation 6, we calculate that R3 needs to be greater than around 34.28 Ω . Adding additional headroom to this, we can calculate R3 = 36 Ω and R4 = 1464 Ω .



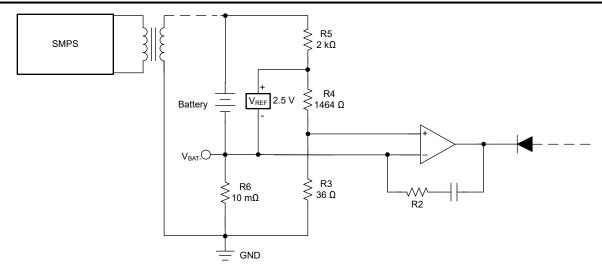


Figure 8-1. Constant Current Feedback Circuit

8.2.1.2.2 Constant Voltage Circuit

For the constant voltage feedback circuit, resistors R8 and R9 divide down the battery voltage to compare against the TL103Wx's reference. This is shown in Figure 8-2. The voltage at the inverting input of the amplifier is designed to equal 2.5 V when the battery reaches its maximum specified voltage (or desired constant voltage value). This is shown in for a maximum voltage of 20 V specified in Table 8-1.

$$V_{BAT} \times \frac{R9}{R8 + R9} = 2.5 V \tag{7}$$

$$20 V \times \frac{R9}{R8 + R9} = 2.5 V \tag{8}$$

To mimic the constant current circuit and achieve a total impedance and 2 k Ω across the battery, R8 is set to 1.96 k Ω and R9 to 280 Ω .

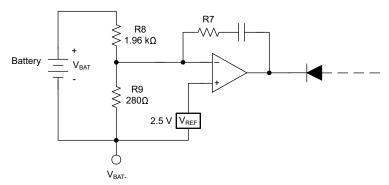


Figure 8-2. Constant Voltage Circuit

8.2.2 Constant Current Sink

Figure 8-3 shows the use of the TL103Wx along with a transistor to provide a constant current sink source. This type of circuit is common in LED drivers and can provide accurate performance and high bandwidth with minimal external components. Accuracy of this circuit is dominated by the reference voltage tolerance, amplifier offset voltage, and resistor tolerance. R_{LIM} is placed to limit the shunt current of the circuit's reference to a maximum of 100 mA.

$$I_{SINK} = \left(V_{REF} \times \frac{R_2}{R_1 + R_2}\right) \times R_S \tag{9}$$



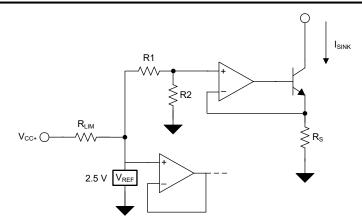


Figure 8-3. TL103Wx as Constant Current Sink

8.3 Power Supply Recommendations

Place 0.1-µF bypass capacitors close to the power-supply pins to reduce errors coupling in from noisy or high-impedance power supplies. For more detailed information on bypass capacitor placement, see Section 8.4

8.4 Layout

8.4.1 Layout Guidelines

For best operational performance of the device, use good PCB layout practices, including:

- Noise can propagate into analog circuitry through the power pins of the circuit as a whole, as well as the
 operational amplifier. Bypass capacitors are used to reduce the coupled noise by providing low-impedance
 power sources local to the analog circuitry.
 - Connect low-ESR, 0.1-µF ceramic bypass capacitors between each supply pin and ground, placed as close to the device as possible. A single bypass capacitor from V+ to ground is applicable for singlesupply applications.
 - If a bypass capacitor is needed to help stabilize the reference, place this capacitor as close to the reference pin as possible.
- Separate grounding for analog and digital portions of circuitry is one of the simplest and most-effective
 methods of noise suppression. One or more layers on multilayer PCBs are usually devoted to ground planes.
 A ground plane helps distribute heat and reduces EMI noise pickup. Make sure to physically separate digital
 and analog grounds, paying attention to the flow of the ground current.
- To reduce parasitic coupling, run the input traces as far away from the supply or output traces as possible. If
 not possible to keep them separate, cross the sensitive trace perpendicular as opposed to in parallel with the
 noisy trace.
- Place the external components as close to the device as possible. Keeping R_F and R_G close to the inverting input minimizes parasitic capacitance, as shown in Section 8.4.2.
- Keep the length of input traces as short as possible. Always remember that the input traces are the most sensitive part of the circuit.
- Consider a driven, low-impedance guard ring around the critical traces. A guard ring can significantly reduce leakage currents from nearby traces that are at different potentials.
- For applications shunting high currents through the reference, pay attention to the cathode and anode traces. Ensure the width of these traces are designed with proper current density.



8.4.2 Layout Example

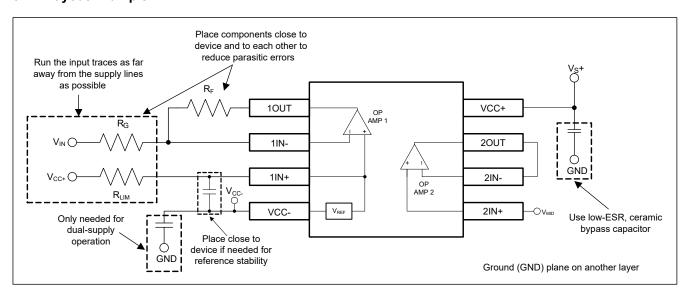


Figure 8-4. Operational Amplifier Board Layout for Inverting Configuration

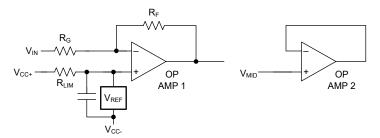


Figure 8-5. Operational Amplifier Schematic for Inverting Configuration



9 Device and Documentation Support

9.1 Documentation Support

9.1.1 Related Documentation

For related documentation, see the following:

- · Texas Instruments, EMI Rejection Ratio of Operational Amplifiers application report
- Texas Instruments, Designing CC-CV Feedback Circuits With the TL103WB

9.2 Receiving Notification of Documentation Updates

To receive notification of documentation updates, navigate to the device product folder on ti.com. Click on *Subscribe to updates* to register and receive a weekly digest of any product information that has changed. For change details, review the revision history included in any revised document.

9.3 Support Resources

TI E2E[™] support forums are an engineer's go-to source for fast, verified answers and design help — straight from the experts. Search existing answers or ask your own question to get the quick design help you need.

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9.5 Electrostatic Discharge Caution



This integrated circuit can be damaged by ESD. Texas Instruments recommends that all integrated circuits be handled with appropriate precautions. Failure to observe proper handling and installation procedures can cause damage.

ESD damage can range from subtle performance degradation to complete device failure. Precision integrated circuits may be more susceptible to damage because very small parametric changes could cause the device not to meet its published specifications.

9.6 Glossary

TI Glossary

This glossary lists and explains terms, acronyms, and definitions.

10 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
PTL103WBIDR	ACTIVE	SOIC	D	8	3000	TBD	Call TI	Call TI	-40 to 125		Samples
TL103WAID	LIFEBUY	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	Z103WA	
TL103WAIDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	Z103WA	Samples
TL103WID	LIFEBUY	SOIC	D	8	75	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	Z103W	
TL103WIDR	ACTIVE	SOIC	D	8	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 105	Z103W	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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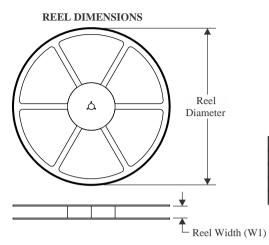
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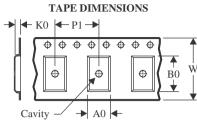
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PACKAGE MATERIALS INFORMATION

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TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing			Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TL103WAIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1
TL103WIDR	SOIC	D	8	2500	330.0	12.4	6.4	5.2	2.1	8.0	12.0	Q1

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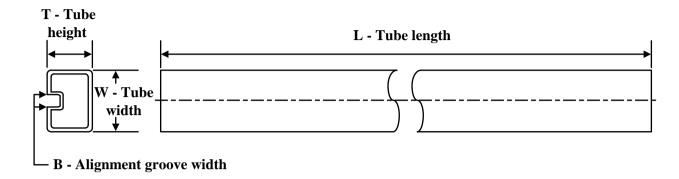
*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TL103WAIDR	SOIC	D	8	2500	340.5	336.1	25.0
TL103WIDR	SOIC	D	8	2500	340.5	336.1	25.0

PACKAGE MATERIALS INFORMATION

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TUBE



*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
TL103WAID	D	SOIC	8	75	507	8	3940	4.32
TL103WID	D	SOIC	8	75	507	8	3940	4.32

PACKAGE OUTLINE

SOIC - 1.75 mm max height

SMALL OUTLINE INTEGRATED CIRCUIT



NOTES:

- 1. Linear dimensions are in inches [millimeters]. Dimensions in parenthesis are for reference only. Controlling dimensions are in inches. Dimensioning and tolerancing per ASME Y14.5M.
- 2. This drawing is subject to change without notice.
- 3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed .006 [0.15] per side.
- 4. This dimension does not include interlead flash.5. Reference JEDEC registration MS-012, variation AA.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

6. Publication IPC-7351 may have alternate designs.

7. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SMALL OUTLINE INTEGRATED CIRCUIT



NOTES: (continued)

- 8. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 9. Board assembly site may have different recommendations for stencil design.



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